504858168 04/09/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

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EPAS ID: PAT4904907

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YUNHWA CHOI	06/02/2017
JEONGHUN CHO	06/02/2017

RECEIVING PARTY DATA

Name:	JMJ KOREA CO., LTD.
Street Address:	102, GILJU-RO 425BEON-GIL, WONMI-GU, GYEONGGI-DO
City:	BUCHEON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	14487

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15947877

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NAME OF SUBMITTER:	SEONG IL JEONG
SIGNATURE:	/SEONG IL JEONG/
DATE SIGNED:	04/09/2018

Total Attachments: 2

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PATENT 504858168 REEL: 045474 FRAME: 0674

ASSIGNMENT OF INVENTION AND PATENT APPLICATION

WHEREAS, WE, YUNHWA CHOI and JEONGHUN CHO (hereinafter together referred to as "ASSIGNORS"), each residing in 105-1004, 12, Gilju-ro 377beon-gil, Wonmi-gu, Bucheon-si, Gyeonggi-do 14529, Republic of Korea and 402-906, 171, Hwajung-ro, Deogyang-gu, Goyang-si, Gyeonggi-do 10475, Republic of Korea, respectively, invented certain new and useful improvements disclosed in an application for United States Letters Patent,

entitled: <u>SEMICONDUCTOR CHIP PACKAGE HAVING HEAT DISSIPATING</u>
<u>STRUCTURE</u>, and

filed on: June 08, 2017 (Application Serial No.: 15/617,126); and

WHEREAS, JMJ KOREA CO., LTD. (hereinafter "ASSIGNEE"), an entity whose business address is 102, Gilju-ro 425beon-gil, Wonmi-gu, Bucheon-si, Gyeonggi-do 14487, Republic of Korea, desires to acquire the entire right, title and interest in and to said improvements and application, and to any United States patents to be obtained therefor.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged:

ASSIGNORS hereby sell, assign, transfer and set over unto ASSIGNEE the entire right, title, and interest in and to the invention, the application for United States patent therefor and all divisions, substitutions, continuations, and continuation-in-part thereof, and any United States patent that may be granted thereon and all reissues and extensions thereof;

ASSIGNORS hereby authorize and request the Commissioner for Patents to issue any resulting patents for the invention to ASSIGNEE in accordance with the terms of this assignment;

ASSIGNORS hereby covenant that ASSIGNORS have full right to convey the entire interest herein assigned, and that ASSIGNORS have not executed, and will not execute any agreement in conflict herewith;

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Assignment of Ownership Attorney Docket: PS170047CYH

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ASSIGNORS hereby further covenant and agree that ASSIGNORS will cooperate with ASSIGNEE in the prosecution of the application, testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute and reissue applications, make all rightful oaths, and perform such other acts as ASSIGNEE lawfully may request to obtain and enforce proper patent protection for the invention in any and all countries; and

ASSIGNORS hereby grant the practitioner(s) associated with Customer No. 18769 of KORUS Patent, LLC the power to insert on this Assignment any further identification including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, ASSIGNORS have executed this Assignment on the date below.

Signature: _	CHOI, YUNHWA	Date:	Jun 2, 2017	
	CHOI, YUNHWA			
Signature:	Uo, Jeng hun	Date:	Jun 2, 2017	
C	CHO, JEONGHUN	· · ·		_

RECORDED: 04/09/2018

PATENT REEL: 045474 FRAME: 0676